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**AMENDMENTS TO THE CLAIMS:**

This listing of claims will replace all prior versions, and listings, of claims in the application:

**LISTING OF CLAIMS:**

Claim 1 (currently amended): A laminated ceramic electronic component comprising:

a laminated member including a plurality of stacked ceramic layers having a first ceramic layer and a second ceramic layer which is thinner than said first ceramic layer; and

wiring conductors provided for a certain layer of said ceramic layers and including a via-hole conductor extending through said certain layer and a conductor extending along the principal surface of said certain layer; wherein

via-hole conductors of different ceramic layers have different sectional sizes; and the aspect ratio expressed by H/D is within the range of approximately 0.1 to approximately 3.0, wherein H and D represent the height and radial length for each of said via-hole conductors, respectively;

a first via-hole conductor extends through said first ceramic layer;  
a second via-hole conductor extends through said second ceramic layer; and  
the second ceramic layer is disposed inside the laminated member, such that the  
second ceramic layer is disposed between the first ceramic layer and another layer of  
the plurality of ceramic layers.

Claim 2 (currently amended): A laminated ceramic electronic component according to Claim 1, wherein ~~a first via-hole conductor extends through said first ceramic layer, a second via-hole conductor extends through said second ceramic layer, and the sectional size of said first via-hole conductor is larger than that of said second~~

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via-hole conductor.

**Claim 3 (original):** A laminated ceramic electronic component according to Claim 2, wherein, of all said via-hole conductors, the sectional size of the via-hole conductor extending through the thicker ceramic layer is larger than that of the via-hole conductor extending through the thinner ceramic layer.

**Claim 4 (original):** A laminated ceramic electronic component according to Claim 3, wherein a plurality of said via-hole conductors extending through the same ceramic layer have substantially the same sectional size.

**Claim 5 (canceled).**

**Claim 6 (original):** A laminated ceramic electronic component according to Claim 1, wherein said plurality of ceramic layers have substantially the same dielectric constant.

**Claims 7-12 (canceled).**

**Claim 13 (currently amended):** An electronic device comprising:  
a laminated ceramic electronic component; and  
a wiring board for mounting said laminated ceramic electronic component thereon;

wherein said laminated ceramic electronic component includes a laminated member having a plurality of stacked ceramic layers including a first ceramic layer and a second ceramic layer that is thinner than said first ceramic layer;

wherein wiring conductors are provided for a specific ceramic layer and include a via-hole conductor extending through said specific ceramic layer and a conductor film

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extending along the principal surface of said specific ceramic layer;  
via-hole conductors of different ceramic layers have different sectional sizes; and  
the aspect ratio expressed by H/D is within the range of approximately 0.1 to  
approximately 3.0, wherein H and D represent the height and radial length for each of  
said via-hole conductors, respectively;

a first via-hole conductor extends through said first ceramic layer;  
a second via-hole conductor extends through said second ceramic layer; and  
the second ceramic layer is disposed inside the laminated member, such that the  
second ceramic layer is disposed between the first ceramic layer and another layer of  
the plurality of ceramic layers.

Claim 14 (currently amended): An electronic device according to Claim 13,  
wherein ~~a first via-hole conductor extends through said first ceramic layer, a second via-hole conductor extends through said second ceramic layer, and the sectional size of said first via-hole conductor is larger than that of said second via-hole conductor.~~

Claim 15 (original): An electronic device according to Claim 14, wherein, of all  
said via-hole conductors, the sectional size of the via-hole conductor extending through  
the thicker ceramic layer is larger than that of the via-hole conductor extending through  
the thinner ceramic layer.

Claim 16 (original): An electronic device according to Claim 15, wherein a  
plurality of said via-hole conductors extending through the same ceramic layer have  
substantially the same sectional size.

Claim 17 (canceled).

Claim 18 (original): An electronic device according to Claim 14, wherein said

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plurality of ceramic layers have substantially the same dielectric constant.

Claim 19 (new): An electronic device according to claim 1, wherein a capacitor is provided on the laminated member.

Claim 20 (new): An electronic device according to claim 13, wherein a capacitor is provided on the laminated member.